45 V, 100 mA NPN general-purpose transistors Rev. 8 — 20 August 2012 P

Product data sheet

1. **Product profile**

1.1 General description

NPN general-purpose transistors in Surface-Mounted Device (SMD) plastic packages.

Type number <mark>[1]</mark>	Package	Package			
	NXP	JEITA	JEDEC		
BC847	SOT23	-	TO-236AB	BC857	
BC847A				BC857A	
BC847B				BC857B	
BC847C				BC857C	
BC847W	SOT323	SC-70	-	BC857W	
BC847AW				BC857AW	
BC847BW				BC857BW	
BC847CW				BC857CW	
BC847T	SOT416	SC-75	-	BC857T	
BC847AT				BC857AT	
BC847BT				BC857BT	
BC847CT				BC857CT	
BC847AM	SOT883	SC-101	-	BC857AM	
BC847BM				BC857BM	
BC847CM				BC857CM	

[1] Valid for all available selection groups.

1.2 Features and benefits

- General-purpose transistors
- SMD plastic packages
- Three different gain selections

1.3 Applications

General-purpose switching and amplification



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1.4 Quick reference data

Table 2.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	45	V
I _C	collector current		-	-	100	mA
h _{FE}	DC current gain	V_{CE} = 5 V; I_C = 2 mA	110	-	800	
	h _{FE} group A		110	180	220	
	h _{FE} group B		200	290	450	
	h _{FE} group C		420	520	800	

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
SOT23, S	OT323, SOT416		
1	base		
2	emitter	3	3
3	collector	1 2 006aaa144	1
SOT883			
1	base		
2	emitter		3
3	collector	2 Transparent top view	1

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3. Ordering information

Type number ^[1]	Package	Package				
	Name	Description	Version			
BC847	-	plastic surface-mounted package; 3 leads	SOT23			
BC847A						
BC847B						
BC847C						
BC847W	SC-70	plastic surface-mounted package; 3 leads	SOT323			
BC847AW						
BC847BW						
BC847CW						
BC847T	SC-75	plastic surface-mounted package; 3 leads	SOT416			
BC847AT						
BC847BT						
BC847CT						
BC847AM	SC-101	leadless ultra small plastic package; 3 solder lands;	SOT883			
BC847BM		body $1.0 \times 0.6 \times 0.5$ mm				
BC847CM						

[1] Valid for all available selection groups.

4. Marking

Table 5.Marking codes

Type number	Marking code ^[1]	Type number	Marking code ^[1]			
BC847	1H*	BC847T	1N			
BC847A	1E*	BC847AT	1E			
BC847B	1F*	BC847BT	1F			
BC847C	1G*	BC847CT	1G			
BC847W	1H*	BC847AM	D4			
BC847AW	1E*	BC847BM	D5			
BC847BW	1F*	BC847CM	D6			
BC847CW	1G*					
		I				

[1] * = placeholder for manufacturing site code

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5. Limiting values

Table 6. In accorda	Limiting values nce with the Absolute Maximu	m Rating System (IEC	C 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	45	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	100	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 ms$	-	100	mA
P _{tot}	total power dissipation	$T_{amb} \leq 25 ~^{\circ}C$	<u>[1]</u>		
	SOT23		-	250	mW
	SOT323		-	200	mW
	SOT416		-	150	mW
	SOT883		[2] _	250	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB with 60 μ m copper strip line, standard footprint.

6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
un(a)	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	SOT23		-	-	500	K/W
	SOT323		-	-	625	K/W
	SOT416		-	-	833	K/W
	SOT883		[2]	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

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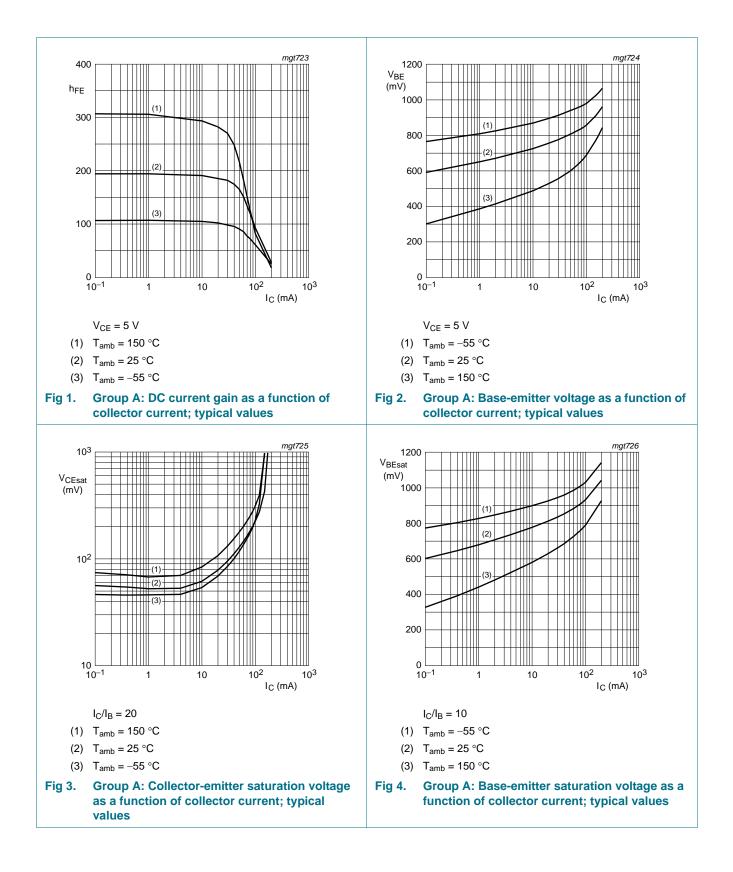
7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	15	nA
	current	$V_{CB} = 30 \text{ V}; \text{ I}_E = 0 \text{ A};$ $T_j = 150 ^{\circ}\text{C}$		-	-	5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain	V_{CE} = 5 V; I_{C} = 10 μ A					
	h _{FE} group A			-	90	-	
	h _{FE} group B			-	150	-	
	h _{FE} group C			-	270	-	
	DC current gain	$V_{CE} = 5 \text{ V}; I_C = 2 \text{ mA}$		110	-	800	
	h _{FE} group A			110	180	220	
	h _{FE} group B			200	290	450	
	h _{FE} group C			420	520	800	
V _{CEsat}	collector-emitter saturation voltage	I_{C} = 10 mA; I_{B} = 0.5 mA		-	90	200	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[1]	-	200	400	mV
V _{BEsat}	base-emitter saturation voltage	I_{C} = 10 mA; I_{B} = 0.5 mA	[2]	-	700	-	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[2]	-	900	-	mV
V _{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	[2]	580	660	700	mV
		I_C = 10 mA; V_{CE} = 5 V		-	-	770	mV
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		100	-	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz		-	-	1.5	pF
C _e	emitter capacitance	$V_{EB} = 0.5 \text{ V}; I_{C} = i_{c} = 0 \text{ A};$ f = 1 MHz		-	11	-	pF
NF	noise figure	$I_C = 200 \ \mu$ A; V _{CE} = 5 V; R _S = 2 kΩ; f = 1 kHz; B = 200 Hz		-	2	10	dB

[2] $$V_{\text{BE}}$$ decreases by approximately 2 mV/K with increasing temperature.

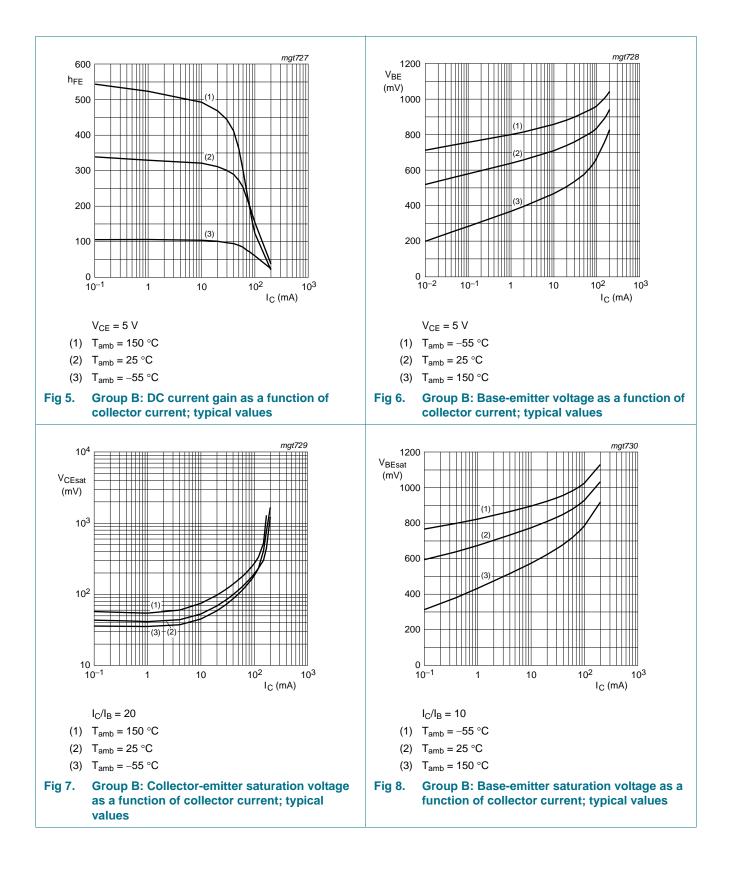
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BC847 series



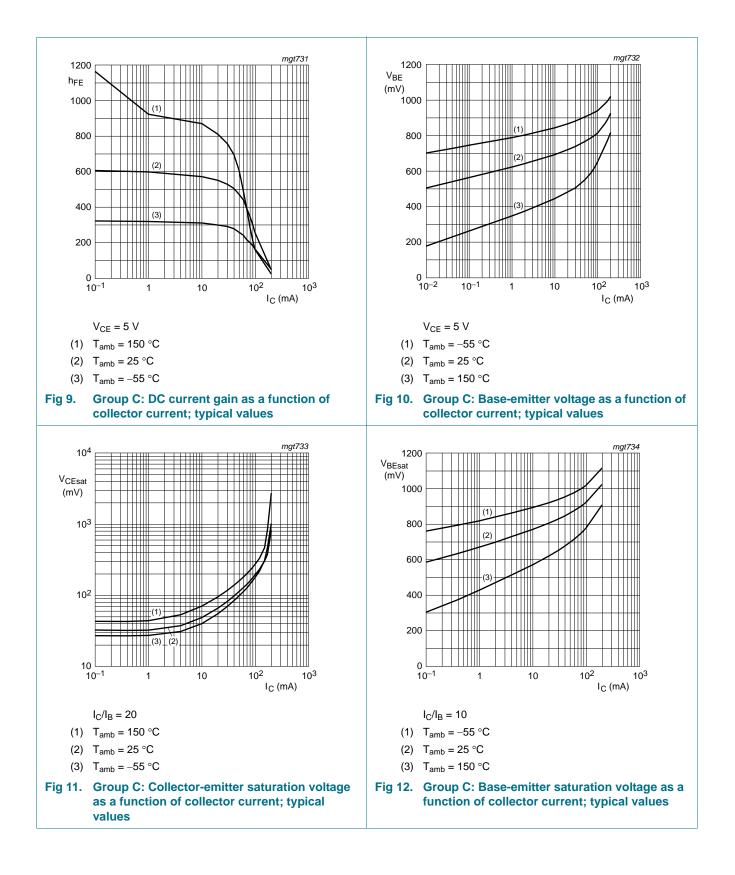
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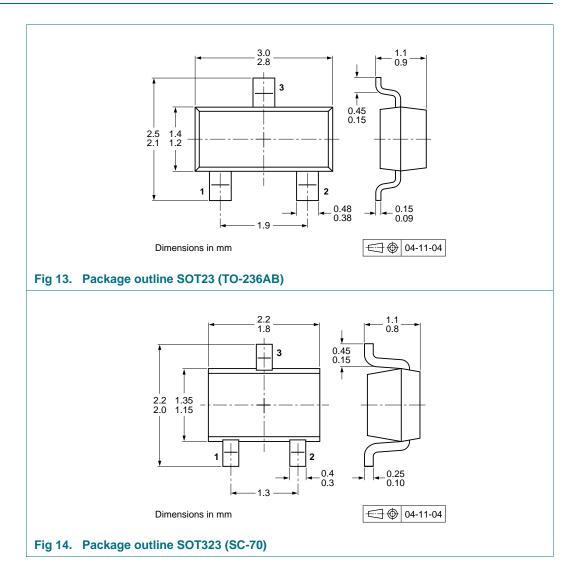
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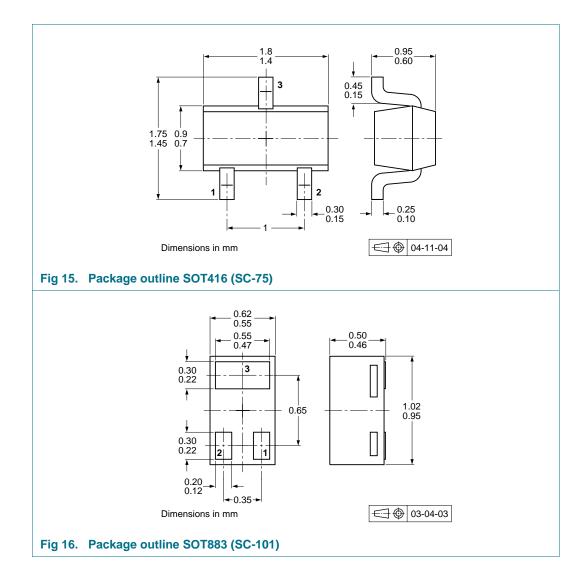
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8. Package outline





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9. Packing information

Table 9. Packing methods The indicated -xxx are the last three digits of the 12NC ordering code.[1]							
Туре	Package	Description	Packir	Packing quantity			
number ^[2]			3000	5000	10000		
BC847	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235		
BC847A							
BC847B							
BC847C							
BC847W	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135		
BC847AW							
BC847BW							
BC847CW							
BC847T	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135		
BC847AT							
BC847BT							
BC847CT							
BC847AM	SOT883	2 mm pitch, 8 mm tape and reel	-	-	-315		
BC847BM							
BC847CM							

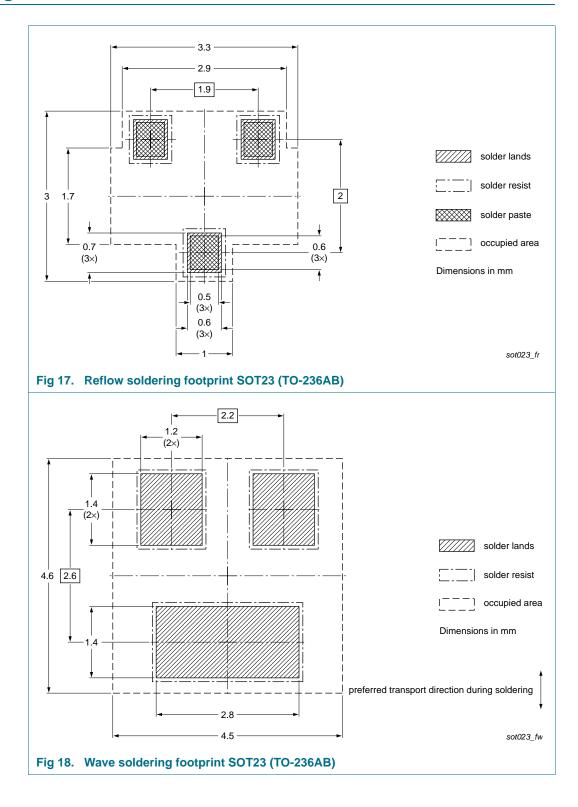
[1] For further information and the availability of packing methods, see <u>Section 13</u>.

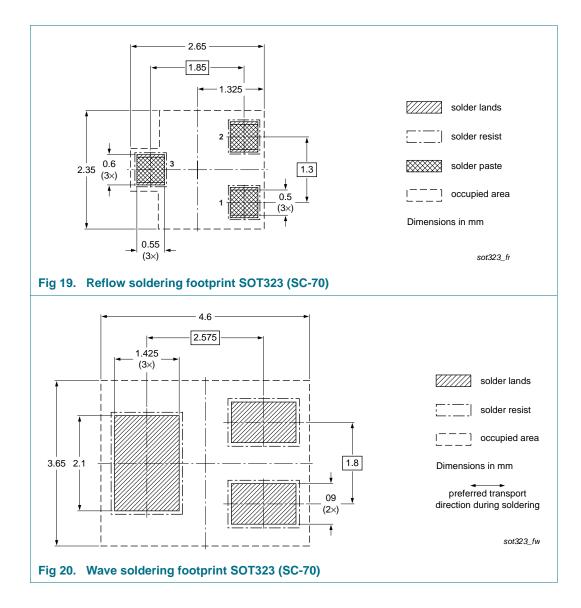
[2] Valid for all available selection groups.

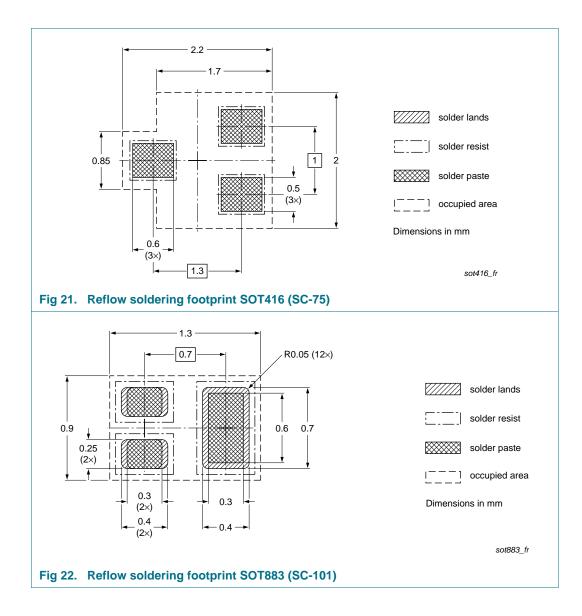
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10. Soldering







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11. Revision history

Table 10. Revision history	1				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BC847_SER v.8	20120820	Product data sheet	-	BC847_BC547_SER v.7	
Modifications: • Type numbers removed: BC847B/DG, BC847BW/DG, BC847AT/DG, BC857, BC857B and BC857C					
	Section 12	"Legal information": updat	ed		
BC847_BC547_SER v.7	20081210	Product data sheet	-	BC847_BC547_SER v.6	
BC847_BC547_SER v.6	20050519	Product data sheet	-	-	

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12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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BC847 SER

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